

Eilam Yalon

List of Publications by Year in Descending Order

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The third column is the impact factor (IF) of the journal, and the fourth column is the number of citations of the article.

63 papers	1,352 citations	19 h-index	36 g-index
70 ext. papers	1,745 ext. citations	6.3 avg, IF	4.68 L-index

#	Paper	IF	Citations
63	Joule-heating induced phase transition in 1T-TaS ₂ near room temperature probed by thermal imaging of power dissipation. <i>Applied Physics Letters</i> , 2022 , 120, 083502	3.4	
62	Temperature-dependent thermal resistance of phase change memory. <i>Applied Physics Letters</i> , 2022 , 120, 113501	3.4	
61	Direct measurement of nanoscale filamentary hot spots in resistive memory devices.. <i>Science Advances</i> , 2022 , 8, eabk1514	14.3	5
60	Uncovering Phase Change Memory Energy Limits by Sub-Nanosecond Probing of Power Dissipation Dynamics. <i>Advanced Electronic Materials</i> , 2021 , 7, 2100217	6.4	4
59	Radiofrequency Switches Based on Emerging Resistive Memory Technologies - A Survey. <i>Proceedings of the IEEE</i> , 2021 , 109, 77-95	14.3	12
58	High Current Density in Monolayer MoS Doped by AlO. <i>ACS Nano</i> , 2021 , 15, 1587-1596	16.7	33
57	Indirectly Heated Switch as a Platform for Nanosecond Probing of Phase Transition Properties in Chalcogenides. <i>IEEE Transactions on Electron Devices</i> , 2021 , 68, 1298-1303	2.9	1
56	Sub-Nanosecond Pulses Enable Partial Reset for Analog Phase Change Memory. <i>IEEE Electron Device Letters</i> , 2021 , 42, 1291-1294	4.4	4
55	Field Effect Transistors: Engineering Field Effect Transistors with 2D Semiconducting Channels: Status and Prospects (Adv. Funct. Mater. 18/2020). <i>Advanced Functional Materials</i> , 2020 , 30, 2070116	15.6	
54	Oxide 2D electron gases as a reservoir of defects for resistive switching. <i>Applied Physics Letters</i> , 2020 , 116, 223503	3.4	7
53	Role of temperature on structure and electrical properties of titanium nitride films grown by low pressure plasma enhanced atomic layer deposition. <i>Journal of Vacuum Science and Technology A: Vacuum, Surfaces and Films</i> , 2020 , 38, 032403	2.9	7
52	Localized Heating and Switching in MoTe-Based Resistive Memory Devices. <i>Nano Letters</i> , 2020 , 20, 1461-1467	14.5	19
51	Improved Current Density and Contact Resistance in Bilayer MoSe Field Effect Transistors by AlO Capping. <i>ACS Applied Materials & Interfaces</i> , 2020 , 12, 36355-36361	9.5	15
50	Band structure and electronic transport across Ta ₂ O ₅ /Nb:SrTiO ₃ interfaces. <i>Journal of Applied Physics</i> , 2020 , 128, 045306	2.5	3
49	Zero temperature coefficient of resistance in back-end-of-the-line compatible titanium aluminum nitride films by atomic layer deposition. <i>Applied Physics Letters</i> , 2020 , 117, 041902	3.4	2
48	Electrical and structural properties of conductive nitride films grown by plasma enhanced atomic layer deposition with significant ion bombardment effect. <i>Journal of Applied Physics</i> , 2020 , 128, 065301	2.5	3
47	Compact Modeling and Electrothermal Measurements of Indirectly Heated Phase-Change RF Switches. <i>IEEE Transactions on Electron Devices</i> , 2020 , 67, 5182-5187	2.9	4

46	Uncovering the Effects of Metal Contacts on Monolayer MoS. <i>ACS Nano</i> , 2020 , 14, 14798-14808	16.7	33
45	Engineering Field Effect Transistors with 2D Semiconducting Channels: Status and Prospects. <i>Advanced Functional Materials</i> , 2020 , 30, 1901971	15.6	36
44	. <i>IEEE Transactions on Electron Devices</i> , 2019 , 66, 3816-3821	2.9	12
43	A Dual-Band CMOS Low-Noise Amplifier using Memristor-Based Tunable Inductors 2019 ,		3
42	Understanding the switching mechanism of interfacial phase change memory. <i>Journal of Applied Physics</i> , 2019 , 125, 184501	2.5	21
41	Energy-Efficient Indirectly Heated Phase Change RF Switch. <i>IEEE Electron Device Letters</i> , 2019 , 40, 455-458	4.4	11
40	Engineering thermal and electrical interface properties of phase change memory with monolayer MoS2. <i>Applied Physics Letters</i> , 2019 , 114, 082103	3.4	26
39	Ultrahigh thermal isolation across heterogeneously layered two-dimensional materials. <i>Science Advances</i> , 2019 , 5, eaax1325	14.3	98
38	Understanding leakage currents through Al2O3 on SrTiO3. <i>Journal of Applied Physics</i> , 2019 , 126, 185301	2.5	5
37	Reconfigurable infrared spectral imaging with phase change materials 2019 ,		2
36	Thermal transport across graphene step junctions. <i>2D Materials</i> , 2019 , 6, 011005	5.9	11
35	Recommended Methods to Study Resistive Switching Devices. <i>Advanced Electronic Materials</i> , 2019 , 5, 1800143	6.4	297
34	Nanoscale Heterogeneities in Monolayer MoSe2 Revealed by Correlated Scanning Probe Microscopy and Tip-Enhanced Raman Spectroscopy. <i>ACS Applied Nano Materials</i> , 2018 , 1, 572-579	5.6	34
33	Energy-Efficient Phase Change Memory Programming by Nanosecond Pulses 2018 ,		2
32	Research Update: Recent progress on 2D materials beyond graphene: From ripples, defects, intercalation, and valley dynamics to straintronics and power dissipation. <i>APL Materials</i> , 2018 , 6, 080701	5.7	22
31	Probing Self-Heating in RRAM Devices by Sub-100 nm Spatially Resolved Thermometry 2018 ,		4
30	Sub-Thermionic Steep Switching in Hole-Doped WSe2 Transistors 2018 ,		2
29	Rapid Flame Synthesis of Atomically Thin MoO down to Monolayer Thickness for Effective Hole Doping of WSe. <i>Nano Letters</i> , 2017 , 17, 3854-3861	11.5	84

28	Effect of oxygen vacancies and strain on the phonon spectrum of HfO ₂ thin films. <i>Journal of Applied Physics</i> , 2017 , 121, 224101	2.5	8
27	Energy Dissipation in Monolayer MoS Electronics. <i>Nano Letters</i> , 2017 , 17, 3429-3433	11.5	134
26	Temperature-Dependent Thermal Boundary Conductance of Monolayer MoS by Raman Thermometry. <i>ACS Applied Materials & Interfaces</i> , 2017 , 9, 43013-43020	9.5	87
25	Effective n-type doping of monolayer MoS ₂ by AlO _x 2017 ,		19
24	Spatially Resolved Thermometry of Resistive Memory Devices. <i>Scientific Reports</i> , 2017 , 7, 15360	4.9	34
23	Thermal boundary conductance of the MOS ₂ -SiO ₂ interface 2017 ,		1
22	Dual-Layer Dielectric Stack for Thermally Isolated Low-Energy Phase-Change Memory. <i>IEEE Transactions on Electron Devices</i> , 2017 , 64, 4496-4502	2.9	22
21	Direct observation of power dissipation in monolayer MoS ₂ devices 2016 ,		1
20	Towards ultimate scaling limits of phase-change memory 2016 ,		16
19	On the diameter dependence of metal-nanowire Schottky barrier height. <i>Journal of Applied Physics</i> , 2015 , 117, 034308	2.5	13
18	On the direction of the conductive filament growth in valence change memory devices during electroforming. <i>Solid State Ionics</i> , 2015 , 276, 9-17	3.3	17
17	Field-Induced Nucleation in the Presence of a Metal Electrode. <i>Physical Review Applied</i> , 2015 , 3,	4.3	5
16	Validation and Extension of Local Temperature Evaluation of Conductive Filaments in RRAM Devices. <i>IEEE Transactions on Electron Devices</i> , 2015 , 62, 3671-3677	2.9	6
15	Thermometry of Filamentary RRAM Devices. <i>IEEE Transactions on Electron Devices</i> , 2015 , 62, 2972-2977	2.9	27
14	Detection of the insulating gap and conductive filament growth direction in resistive memories. <i>Nanoscale</i> , 2015 , 7, 15434-41	7.7	27
13	Dual bipolar resistive switching in the sub-forming regime of HfO ₂ resistive switching devices. <i>Solid-State Electronics</i> , 2015 , 111, 238-242	1.7	5
12	Thermal modeling of metal oxides for highly scaled nanoscale RRAM 2015 ,		2
11	Heat Dissipation in Resistive Switching Devices: Comparison of Thermal Simulations and Experimental Results. <i>IEEE Transactions on Electron Devices</i> , 2014 , 61, 1137-1144	2.9	20

10	2014,			3
9	Comparison of Simulation and Measurement of Gate Leakage Current in Metal/Al ₂ O ₃ /GaN/AlGaN/AlN/GaN Capacitors. <i>IEEE Transactions on Electron Devices</i> , 2014 , 61, 3558-3561 ^{2,9}			3
8	Nanosession: Valence Change Memories - A Look Inside 2013 , 233-245			
7	Heat dissipation mechanisms in resistive switching devices 2013 ,			1
6	2013,			1
5	Evaluation of the local temperature of conductive filaments in resistive switching materials. <i>Nanotechnology</i> , 2012 , 23, 465201	3-4		27
4	Resistive Switching in HfO_2 Probed by a Metal/Insulator/Semiconductor Bipolar Transistor. <i>IEEE Electron Device Letters</i> , 2012 , 33, 11-13	4-4		3 ¹
3	A Degenerately Doped $\text{In}_{0.53}\text{Ga}_{0.47}\text{As}$ Bipolar Junction Transistor. <i>IEEE Electron Device Letters</i> , 2011 , 32, 21-23	4-4		5
2	Tunneling Emitter Bipolar Transistor as a Characterization Tool for Dielectrics and their Interfaces. <i>ECS Transactions</i> , 2011 , 41, 325-334	1		4
1	Temperature of Conductive Nanofilaments in Hexagonal Boron Nitride Based Memristors Showing Threshold Resistive Switching. <i>Advanced Electronic Materials</i> , 2100580	6-4		4